## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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SERIAL NO.:

FILED:

Herewith

TITLE: ION IMPLANTING APPARATUS

## PRELIMINARY AMENDMENT

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

Sir:

In conjunction with the filing of the present application, and prior to an initial Official Action on this matter, please amend the above-identified application as follows:

## Preliminary Amendment: SPECIFICATION AMENDMENTS

In Paragraph [0010], please amend the paragraph as follows:

Other objectives and advantages of the present invention will become apparent upon reading the following descriptions and upon reference to the accompanying drawings in which:

In Paragraphs [0011], please amend the paragraph as follows:

FIG. 1 and FIG. 2 show are cross-sectional and perspective views showing a portion of an ion implanting apparatus according to the present invention; and.

In Paragraphs [0012], please amend the paragraph as follows:

FIG. 3 is a schematic view diagram of an ion implanting apparatus according to the present invention.

## IN THE ABSTRACT

On page 15, please amend the Abstract as follows:

The ion implanting apparatus of the present invention comprises has a wafer cassette capable of loading a plurality of wafers, an implanting chamber including an implanting base, a cassettetransferring module for moving the wafer cassette, and a wafer-transferring module for moving the wafer from the wafer cassette to the implanting base. The wafer cassette comprises has a plurality of irradiation tray for loading the wafer, while the implanting base comprises includes a guiding slot for guiding the irradiation tray. The cassette-transferring module comprises has a rack positioned on the wafer cassette, a gear for moving the wafer cassette by driving the rack through rotating, and a first stepping motor for driving the gear. The wafer-transferring module comprises includes a push plate for moving the irradiation tray from the wafer cassette to the implanting base, and a second stepping motor for driving the push plate.